



SPECIFICATION (Reference sheet)

· Supplier : Samsung electro-mechanics · Samsung P/N : CL31B104KEHSW6E

Product : Multi-layer Ceramic Capacitor

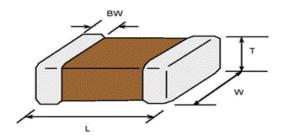
Description : CAP, 100 nF, 250V, ±10%, X7R, 1206

A. Samsung Part Number

<u>CL</u> <u>31</u> <u>B</u> <u>104</u> <u>K</u> <u>E</u> <u>H</u> <u>S</u> <u>W</u> <u>6</u> <u>E</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

		Samsur	ng Multi-	i-layer	Ceran	nic Ca	pacito	or				
		1206	(inch o	code)		L:	3.20	± 0.20 mm	W :	1.60 ± 0.20) mm	
		X7F	₹				8	Inner electrode		Ni		
е		100) nF					Termination		Soft termin	ation	
е		±10	0 %					Plating		Sn 100%	(Pt	Free)
							9	Product		Industrial (Network	(,Power,etc)
ag	je	250) V				10	Special		Higher ben	ding str	ength
	1	1.60 ± (0.20 mm				11)	Packaging		Embossed	Type, 7	7" reel
ag							_	•		•		•

B. Structure & Dimension



Samsung P/N	Dimension(mm)						
Samsung 1714	L	W	Т	BW			
CL31B104KEHSW6E	3.20 ± 0.20	1.60 ± 0.20	1.60 ± 0.20	0.50 ± 0.30			

C. Samsung Reliablility Test and Judgement Condition

	Judgement	Test condition			
Capacitance	Within specified tolerance	1kHz ±10% / 1.0±0.2Vrms			
Tan δ (DF)	0.025 max.	*A capacitor prior to measuring the capacitance is heat treated at 150 °C+0/-10 °C for 1hour and maintained in ambient air for 24±2 hours.			
Insulation	10,000Mohm or 500Mohm× <i>µ</i> F	Rated Voltage 60±5 sec.			
Resistance	Whichever is smaller				
Appearance	No abnormal exterior appearance	Microscope (×10)			
Withstanding	No dielectric breakdown or	200% of the rated voltage			
Voltage	mechanical breakdown				
Temperature	X7R				
Characteristics	(From -55°C to 125°C, Capacitance change	should be within ±15%)			
Adhesive Strength	No peeling shall be occur on the	500g·f, for 10±1 sec.			
of Termination	terminal electrode				
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (3mm) with 1.0mm/sec.			
Solderability	More than 95% of terminal surface is to be soldered newly	SnAg3.0Cu0.5 solder 245±5°C, 3±0.3sec. (preheating : 80~120°C for 10~30sec.)			
Resistance to	Capacitance change: within ±7.5%	Solder pot : 270±5°C, 10±1sec.			
Soldering Heat	Tan δ, IR : initial spec.	A codification of Free Code			
Vibration Test	Capacitance change : within \pm 5% Tan δ , IR : initial spec.	Amplitude: 1.5mm From 10Hz to 55Hz (return: 1min.) 2hours × 3 direction (x, y, z)			
Moisture	Capacitance change: within ±12.5%	With rated voltage			
Resistance	Tan δ: 0.05 max IR: 500Mohm or 25Mohm×μF Whichever is smaller	40±2°C, 90~95%RH, 500+12/-0hrs			
High Temperature Resistance	Capacitance change: within ±12.5% Tan δ: 0.05 max IR: 1,000Mohm or 50Mohm×μF Whichever is smaller	With 150% of the rated voltage Max. operating temperature 1,000+48/-0hrs			
Temperature Cycling	Capacitance change : within ±7.5% Tan δ, IR : initial spec.	1 cycle condition Min. operating temperature → 25°C → Max. operating temperature → 25°C 5 cycle test			

D. Recommended Soldering method:

Reflow (Reflow Peak Temperature : 250 °C, 6sec. max.)



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.

Disclaimer & Limitation of Use and Application

The products listed in this Specification sheet are **NOT** designed and manufactured for any use and applications set forth below.

Please note that any misuse of the products deviating from products specifications or information provided in this Spec sheet may cause serious property damages or personal injury.

We will **NOT** be liable for any damages resulting from any misuse of the products, specifically including using the products for high reliability applications as listed below.

If you have any questions regarding this 'Limitation of Use and Application', you should first contact our sales personnel or application engineers.

- ① Aerospace/Aviation equipment
- 2 Automotive or Transportation equipment (vehicles, trains, ships, etc)
- 3 Medical equipment
- 4 Military equipment
- ⑤ Disaster prevention/crime prevention equipment
- 6 Power plant control equipment
- Atomic energy-related equipment
- Undersea equipment
- Traffic signal equipment
- Data-processing equipment
- ## Electric heating apparatus, burning equipment
- Safety equipment
- ® Any other applications with the same as or similar complexity or reliability to the applications